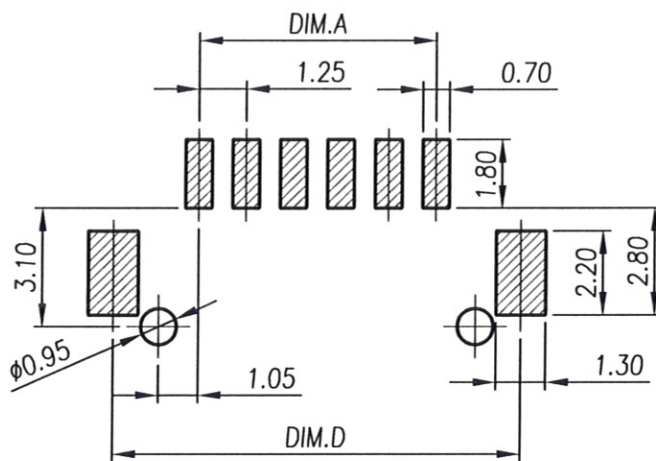
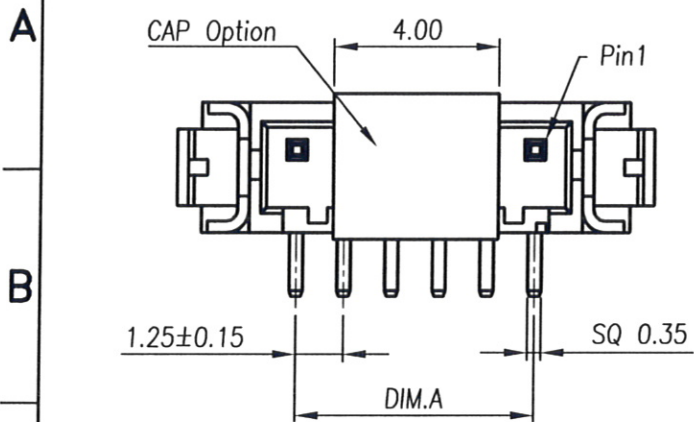


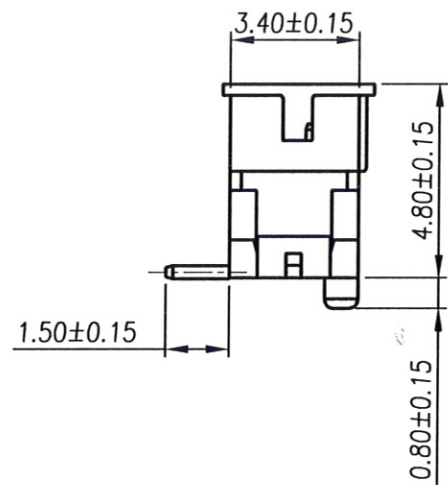
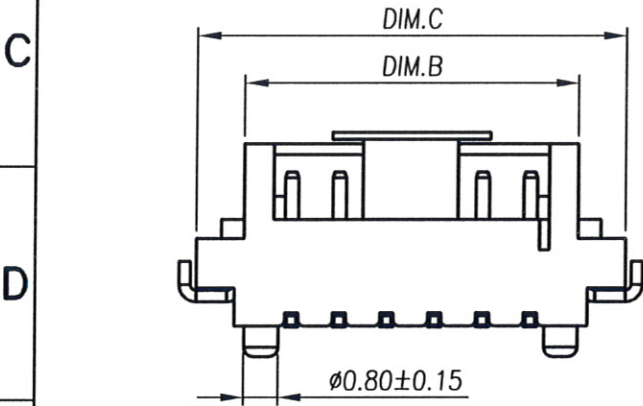
RoHS Compliant



| REV | MODIFICATION | DATE | DRAW |
|-----|------------------------|------------|-------|
| A0 | Release To Production | 2009.10.27 | Abel |
| A1 | Release To ECN20130304 | 2013.03.20 | Seven |



Recommended PCB Layout
(Tolerance±0.05)



Specification

- 1.Current Rating:1A AC/DC
- 2.Voltage Rating:100V AC/DC
- 3.Contact Resistance:30mΩ Max.
- 4.Insulation Resistance:500MΩ Min.
- 5.Withstand Voltage:500V AC/Minute
- 6.Operating Temperature:-25°C~+105°C

Material:

- 1.Housing:High Temp. Thermoplastic UL94V-0
- 2.Contact:Copper Alloy SQ. Pin=0.35mm
- 3.Tab:Copper Alloy T=0.5mm

Finish:

- 1.Housing:Natural
- 2.Contact:Bright Tin Plated
- 3.Tab:Bright Tin Plated

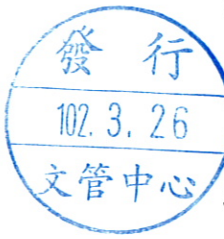
Part No.: AS07702 XX 5 X X 2

Number of Pin 02~15


Packing
0:T&R With CAP
1:T&R Without CAP
3:Tube With CAP
4:Tube Without CAP

Housing Material
5:NY6T UL94V-0 Natural

Plating
1:Bright Tin Plated Over Ni All
2:Matte Tin Plated Over Ni All
3:Gold Flash Over Nickel




| Pin | DIM.A | DIM.B | DIM.C | DIM.D | Pin | DIM.A | DIM.B | DIM.C | DIM.D |
|-----|-------|-------|-------|-------|-----|-------|-------|-------|-------|
| 02 | 1.25 | 4.15 | 6.25 | 5.75 | 09 | 10.00 | 12.90 | 15.00 | 14.50 |
| 03 | 2.50 | 5.40 | 7.50 | 7.00 | 10 | 11.25 | 14.15 | 16.25 | 15.75 |
| 04 | 3.75 | 6.65 | 8.75 | 8.25 | 11 | 12.50 | 15.40 | 17.50 | 17.00 |
| 05 | 5.00 | 7.90 | 10.00 | 9.50 | 12 | 13.75 | 16.65 | 18.75 | 18.25 |
| 06 | 6.25 | 9.15 | 11.25 | 10.75 | 13 | 15.00 | 17.90 | 20.00 | 19.50 |
| 07 | 7.50 | 10.40 | 12.50 | 12.00 | 14 | 16.25 | 19.15 | 21.25 | 20.75 |
| 08 | 8.75 | 11.65 | 13.75 | 13.25 | 15 | 17.50 | 20.40 | 22.50 | 22.00 |



金上達科技股份有限公司

GOLDENSUNDA TECHNOLOGY CO.,LTD

| | | | | | |
|--------------------------------------|-------------|---------------------------------------------------------------------------------------------|---------------------------------------------------|-------------------------|----------------------|
| TOLERANCE UNLESS OTHERWISE SPECIFIED | | PROJ.  | TITLE: Wire To Board Wafer 1.25mm 180° SMT W/Post | | |
| .x± 0.35 | x.*± 2' | APR. Jay 20130320 | PART NO. AS07702XX5XX2 | DWG NO. AS07702XX5XX2 | |
| .xx± 0.25 | .x.*± 1' | CHK. Michelle 20130320 | UNITS: mm | CUSTOMER DRAWING | |
| .xxx± 0.15 | .xx.*± 0.5' | DRA. Seven 20130320 | SIZE: A4 | SCALE: 5:1 | SHEET 1 / 1 REV A1 V |